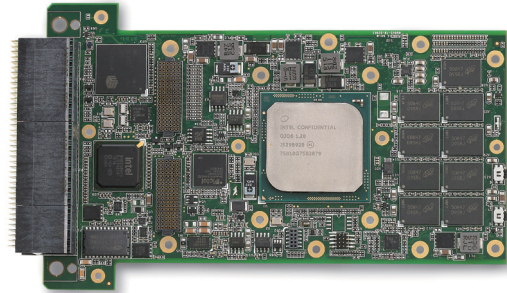


VPX3010 Series

Rugged 3U VPX Intel® Xeon® Processor D-1500 Processor Blade

Features

- Intel® Xeon® Processor D-1500 SoC up to 12 cores (formerly "Broadwell-DE")
- DDR4-2133 soldered ECC SDRAM up to 16GB
- Dual 10G-KR, up to three 1G Ethernet ports
- Up to PCIe x16 Gen3 interface supporting non-transparent bridge
- One XMC expansion slot, PCIe x8 Gen3 with Rear I/O to P2



Specifications

• Processor & System

CPU

Intel® Xeon® D-1559 12-core, 45W TDP
 Intel® Xeon® D-1539 8-core, 35W TDP
 Intel® Pentium® D1519 4-core, 25W TDP

RAM

Dual channel DDR4-2133 ECC soldered SDRAM, up to 16GB

BIOS

AMI EFI on 64Mbit SPI flash

VITA Specifications

VITA 46.0 VPX Base Standard
 VITA 46.4 PCI Express on VPX Fabric Connector
 VITA 46.6 Gigabit Ethernet Control Plane on VPX
 VITA 46.9 PMC/XMC/Ethernet Signal Mapping to 3U/6U VPX
 VITA 46.10 Rear Transition Module on VPX
 VITA 46.11 System Management on VPX
 VITA 48.0 Ruggedized Enhanced Design Implementation Mechanical Base Specification
 VITA 65 OpenVPX Architecture Framework for VPX

Module Profile

MOD3-PAY-2F2T-16.2.5-3

Slot Profile

SLT3-PAY-2F2T-14.2.5

• Connectivity

XMC

PCIe x8 Gen3 with Rear IO to P2 X8d+X12d

Ethernet

Dual 10G-KR to P2
 Two 1000BASE-T to P1 (or one 1000BASE-T and two 1000BASE-BX by BOM option)

Graphics

SMI750 on PCIe x1
 One VGA to P2

USB

One USB 3.0 to P1 and one to P2
 One USB 2.0 to P1

Serial Port

One RS-232 to P1
 One RS-232/422 to P1

PCI Express

PCIe x8 Gen3, configurable to 1 x8 or 2 x4 to P1, supports DMA and non-transparent bridge for peer-to-peer communication
 PCIe x8 Gen3 to P2 (combined with PCIe x8 Gen3 to P1 for PCIe x16 Gen3, no XMC BOM option)
 PCIe x1 Gen3 to P1 (no XMC BOM option)

• Storage

SBC

Soldered SLC NAND flash up to 64GB SATA 6Gb/s

RTM

One SATA 6Gb/s to P1
 One SATA 6Gb/s to P2 (no XMC BOM option)



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Specifications

- **Security Mechanism**

TPM: Atmel TPM version 1,2
IPMC: Smart Fusion A2F200 with VPX code base
BIOS: Dual BIOS mechanism

- **Operating System**
OS

Red Hat Enterprise Linux 6.5
Wind River VxWorks 7.0
Microsoft Windows 7 32/64-bit
Microsoft Windows 7 Embedded (Please contact ADLINK for other OS support)

- **Miscellaneous**

LEDs: Blade status LEDs on front and rear
Watchdog Timer: System reset or NMI with programmable interval
GPIO: Eight 5V tolerance GPIO to P1 and P2
Reset Button: Reset button on front panel

- **Miscellaneous**

Form Factor: 3U VPX 1.0 in. pitch

Operating Temp.

-40°C to +85°C (at wedge locks)
Storage Temp.: -50°C to +100°C

Relative Humidity

95% non-condensing

Shock

5Hz-2KHz, 12Grms, random, each axis, operating

Vibration

Sawtooth 40G, 11ms, each axis, operating
Altitude: 60,000 feet, operating
Power Consumption: TBD
Weight: TBD
Thermal Dissipation: Convection and conduction

- **Safety & EMI**

Certifications: CE, FCC Class A

Ordering Information

Processor Blades

- **VPX3010/1559/M16/S32/XMC-R1**
3U VPX processor board with Intel® Xeon® D-1559, DDR4 16GB, SLC 32GB, dual 10G-KR, dual GbE Base-T, VGA, 2x USB 3.0, XMC slot with coating & ETT -40°C to +75°C
- **VPX3010/1559/M16/S32/P16-R1**
3U VPX processor board with Intel® Xeon® D-1559, DDR4 16GB, SLC 32GB, PCIe x16, dual 10G-KR, 1GbE Base-T and GbE Base-BX, VGA, 2x USB 3.0, with coating & ETT -40°C to +75°C
- **VPX3010/1539/M16/S32/XMC-R1**
3U VPX Processor Board Intel® Xeon® D-1539, DDR4 16GB, SLC 32GB, dual 10G-KR, dual GbE Base-T, VGA, 2x USB 3.0, XMC slot with coating & ETT -40°C to +75°C
- **VPX3010/1539/M16/S32/P16-R1**
3U VPX Processor Board Intel® Xeon® D-1539, DDR4 16GB, SLC 32GB, PCIe x16, dual 10G-KR, 1GbE Base-T and GbE Base-BX, VGA, 2x USB 3.0, with coating & ETT -40°C to +75°C
- **VPX3010/1559/M16/S64/XMC-R1**
3U VPX processor board with Intel® Xeon® D-1559, DDR4 16GB, SLC 64GB, dual 10G-KR, dual GbE Base-T, VGA, 2x USB 3.0, XMC slot with coating & ETT -40°C to +75°C
- **VPX3010/1559/M16/S64/P16-R1**
3U VPX Processor board with Intel® Xeon® D-1559, DDR4 16GB, SLC 64GB, PCIe x16, dual 10G-KR, GbE Base-T and GbE Base-BX, VGA, 2x USB 3.0 with coating & ETT -40°C to +75°C

Rear Transition Modules

- **VPX-R3010**
RTM for VPX3010 with GbE, SATA, USB 3.0/2.0, RS-232, GPIO
- **VPX-R3010L2**
RTM for VPX-R3010 with PCIe x16 slot, PCIe x1 slot
- **VPX-R3010L2-1**
RTM for VPX-R3010 with 10G SFP+ connector

Accessories

- **VPX3G10-R**
3U VPX NVIDIA GT745M GPU blade, 384 CUDA GDDR5 2GB, conduction cooled
- **XMC-G745-R**
XMC NVIDIA GT745M GPGPU module, 384 CUDA GDDR5 2GB, conduction cooled
- **VPX-TF3090**
3U VPX conduction cooled test frame with tBP-VPX3000